



# UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office  
Address: COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, Virginia 22313-1450  
www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/708,399	03/01/2004	Chi-Yang Lin	VIAP0100USA	2398
27765	7590	02/07/2006	EXAMINER	
NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION			STIGLIC, RYAN M	
P.O. BOX 506			ART UNIT	
MERRIFIELD, VA 22116			PAPER NUMBER	

2112

DATE MAILED: 02/07/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

<b>Office Action Summary</b>	<b>Application No.</b>		<b>Applicant(s)</b>	
	10/708,399		LIN ET AL.	
	<b>Examiner</b>		<b>Art Unit</b>	
	Ryan M. Stiglic		2112	

**-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --**

### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

### Status

- 1) ☐ Responsive to communication(s) filed on \_\_\_\_.
- 2a) ☐ This action is **FINAL**.                      2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

### Disposition of Claims

- 4) ☒ Claim(s) 1-13 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-13 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_ are subject to restriction and/or election requirement.

### Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 01 March 2004 is/are: a) ☐ accepted or b) ☒ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

### Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All    b) ☐ Some \*    c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

### Attachment(s)

- |   |   |
|---|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892)             | 4) <input type="checkbox"/> Interview Summary (PTO-413)                     |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)    | Paper No(s)/Mail Date. ____.  |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| Paper No(s)/Mail Date ____.   | 6) <input type="checkbox"/> Other: ____.                                    |

### **DETAILED ACTION**

1. Claims 1-13 are pending and have been examined.
2. Claims 1-13 are rejected.

### ***Drawings***

3. The drawings are objected to because figures 2 and 3 refer to I/O ports 56, 79a-c, 96 and 124a-c as I/O **prot(s)**. Corrected drawing sheets in compliance with 37 CFR 1.121(d) are required in reply to the Office action to avoid abandonment of the application. Any amended replacement drawing sheet should include all of the figures appearing on the immediate prior version of the sheet, even if only one figure is being amended. The figure or figure number of an amended drawing should not be labeled as “amended.” If a drawing figure is to be canceled, the appropriate figure must be removed from the replacement sheet, and where necessary, the remaining figures must be renumbered and appropriate changes made to the brief description of the several views of the drawings for consistency. Additional replacement sheets may be necessary to show the renumbering of the remaining figures. Each drawing sheet submitted after the filing date of an application must be labeled in the top margin as either “Replacement Sheet” or “New Sheet” pursuant to 37 CFR 1.121(d). If the changes are not accepted by the examiner, the applicant will be notified and informed of any required corrective action in the next Office action. The objection to the drawings will not be held in abeyance.

*Claim Rejections - 35 USC § 103*

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

5. Claims 1-8 and 11-13 rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Admitted Prior Art (AAPA) in view of Peleg et al. (US006557065B1) further in view of Baxter, III (US006813689B2).

For claim 1 AAPA discloses:

An SOC (Fig. 1, 41) comprising:

- a processor for controlling operation of the SOC (Fig. 1, 32);
- a high-speed bridge circuit connected to the processor (Fig. 1, 34), the high-speed bridge circuit being used to control signal transmission between the processor and a high-speed peripheral device (Fig. 1, 38) connected to the high-speed bridge circuit (AAPA; [0005]);
- a low-speed bridge circuit connected to the high-speed bridge circuit (Fig. 1, 36), the low-speed bridge circuit being used to control signal transmission between the high-speed bridge circuit and a first low-speed peripheral device (Fig. 1, 42) connected to the low-speed bridge circuit (AAPA; [0005]);

While AAPA discloses a SOC for use in an embedded system (Fig. 1, 30) it does not disclose further connecting the SOC to an external bridge for expanding the connectivity of the embedded system.

Peleg teaches an embedded system (Fig. 4) that consists of an SOC (Fig. 4, 400) comprising a processor for controlling the operation of the SOC (col. 5, ll. 32-53), a graphics processor, and a Northbridge (functions much like the high-speed and low-speed bridges of AAPA). The SOC further comprises an expansion port (not shown, however it is the pins of the SOC 400 that connect to the bus 12) for connecting to the expansion bridge circuit (i.e., "Southbridge Chip", Fig. 4, 30). The Southbridge is responsible for controlling signal transmission between the SOC and low-speed peripheral devices (such as printers, modems, keyboards, mice, CD-ROM drives, hard disk drives...col. 1, line 31- col. 2, line 8).

It would have been obvious to one of ordinary skill in the art at the time of the applicant's invention to connect a Southbridge chip like that of Peleg to a System On a Chip (SOC) like that of AAPA such the functionality and expandability of the embedded system is greatly increased.

While AAPA in view of Peleg teaches an SOC connected to a Southbridge (i.e., expansion bridge circuit) they do not expressly state where Southbridge connects to the internal components of the SOC. Peleg shows as prior art that Southbridge circuits are normally connected to Northbridge circuits (Fig. 1 and 2). Applied to AAPA it appears as though the Southbridge would connect to the low-speed bridge circuit since the Southbridge provides access to additional low speed devices. It would be beneficial to provide a connection between the Southbridge chip and the SOC such that both high-speed devices attached to the high-speed

Art Unit: 2112

bridge circuit and low-speed devices attached to the low-speed bridge circuit are given fast access to the additional devices attached to the Southbridge.

Baxter teaches a system (Fig. 2C) that shows a processor 40 connected to a bus 36 that also connects to two bridges 37 and 43. The two bridges are similar to the high-speed and low-speed bridge circuits of AAPA in view of Peleg in that they control access to devices attached to their subordinate buses. Assuming for sake of example that the Mem controller & I/O Bridge 37 represents the high-speed bridge circuit of AAPA in view of Peleg while the I/O Bridge 43 represents the low-speed bridge circuit. It is clearly demonstrated that the two bridges are connected and they control access to their attached devices (devices 10 and 17). Baxter then contemplates the proper placement of another device Memory 39 that requires fast-access by not only processor 40 but also the devices 10 and 17. The proper placement of the memory 39 is equivalent to the placement of the expansion port (i.e., Southbridge) of AAPA in view of Peleg. By attaching the Southbridge to the low-speed bridge circuit access by the CPU is negatively affected because the CPU needs to go through both the high-speed and low-speed bridge circuits. Likewise, attaching the Southbridge to the high-speed bridge circuit negatively affects access by devices attached to the low-speed bridge since the requests must traverse not only the low-speed bridge but must also go through the high-speed bridge circuit. Baxter provides a solution to this problem in the form of a multiplexer (Fig. 2C, 38).

Baxter teaches a multiplexer (Fig. 2C, 38) for connecting bridges 37 and 43 along with devices 10 and 17 to an additional memory device 39. Had the memory device 39 been connected

Art Unit: 2112

directly to bus 35 access from devices 10 would result in a two “hop” lag because the transaction would need to traverse both I/O Bridge 43 and Mem controller & I/O Bridge 37. A similar situation exists if the memory device 39 was attached only to bus 34. By placing multiplexer 38 between buses 34 and 35 data moved from bus 34 to bus 35 (and vice versa) and data moved between devices attached to buses 34 and 35 (including devices 10 and 17 and bridges 37 and 43) experience less latency because only one hop is needed to transfer data (col. 6, ll. 23-59). Therefore by connecting the Southbridge (as taught by Peleg) to both the high-speed bridge and the low-speed bridge (as disclosed by AAPA) through a multiplexer (as taught by Baxter) the delay required to moved data to and from the Southbridge is reduced.

It would have been obvious to one of ordinary skill in the art at the time of the applicant's invention to connect the Southbridge of Peleg to the both the high-speed and low-speed bridge circuits of AAPA through a multiplexer like that of Baxter such that the delay required to move data from the Southbridge to various embedded system components is reduced.

For claim 2:

The SOC of claim 1 wherein the processor comprises a RISC processor (AAPA; [0005]).

For claim 3:

The SOC of claim 1 further comprising: a multiplexer comprising (Baxter; Fig. 2C, 38):

- an input connected to the expansion port (the port to which the Southbridge of Peleg will attach);



Art Unit: 2112

- a first output connected to the high-speed bridge circuit; and a second output connected to the low-speed bridge circuit (as noted above...by connecting the Southbridge (as taught by Peleg) to both the high-speed bridge and the low-speed bridge (as disclosed by AAPA) through a multiplexer (as taught by Baxter) the delay required to moved data to and from the Southbridge is reduced).

For claim 4:

The SOC of claim 3 wherein the multiplexer connects the input and the first output when the expanding bridge circuit is connected to the expansion port (as noted above...by connecting the Southbridge (as taught by Peleg) to both the high-speed bridge and the low-speed bridge (as disclosed by AAPA) through a multiplexer (as taught by Baxter) the delay required to moved data to and from the Southbridge is reduced).

For claim 5:

The SOC of claim 3 wherein the expansion port is selectively connected to an input/output port of the SOC or to the expanding bridge circuit (as noted above...by connecting the Southbridge (as taught by Peleg) to both the high-speed bridge and the low-speed bridge (as disclosed by AAPA) through a multiplexer (as taught by Baxter) the delay required to moved data to and from the Southbridge is reduced).

For claim 6:



Art Unit: 2112

The SOC of claim 5 wherein the multiplexer connects the input and the second output when the expansion port is connected to the input/output port (as noted above...by connecting the Southbridge (as taught by Peleg) to both the high-speed bridge and the low-speed bridge (as disclosed by AAPA) through a multiplexer (as taught by Baxter) the delay required to moved data to and from the Southbridge is reduced).

For claim 7:

The SOC of claim 1 wherein the low-speed bridge circuit is connected to a first input/output port (AAPA; Fig. 1, 44), and the expanding bridge circuit is connected to a second input/output port (Peleg; Fig. 4, ports connecting to buses 72 and 82); wherein the first input/output port is used to connect to the first low-speed peripheral device (AAPA; [0005]), and the second input/output port is used to connect to the second low-speed peripheral device (Peleg; col. 1, line 31- col. 2, line 8).

For claim 8:

The SOC of claim 1 wherein the expansion port is connected to the expanding bridge circuit using a bus connector (Peleg; Fig. 4, 12).

For claim 11:

The SOC of claim 1 wherein the expanding bridge circuit comprises a south bridge circuit of x86 architecture (Peleg; col. 1, line 31 – col. 2, line 8).

Art Unit: 2112

For claim 12:

The SOC of claim 1 wherein the SOC is installed in a package, and the expansion port comprises a plurality of pinouts of the package (AAPA; [0005-0006]).

For claim 13:

The SOC of claim 1 wherein the SOC is utilized in an embedded system (AAPA; [0005]).

6. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Admitted Prior Art (AAPA) in view of Peleg et al. (US006557065B1) further in view of Baxter, III (US006813689B2) as applied to claim 8 above, and further in view of "DFI Excitedly Introduces Dual Specification Motherboard Adopting VIA KT266/DDR $\phi$ wAD72".

7. As previously discussed above AAPA in view of Peleg teaches a SOC with a bus connection to an expansion bridging circuit (Southbridge). The Southbridge circuit enables the SOC to increase the functionality and expandability of the embedded system. Baxter teaches that by connecting the Southbridge to both the high-speed and low-speed bridging circuits through a multiplexer that the delay required to move data from the Southbridge to various embedded system components is reduced. However, neither AAPA nor Peleg nor Baxter teach the specific protocol used to connect the high-speed/low-speed bridging circuits to the expanding bridge circuit (Southbridge).

Art Unit: 2112

In the article titled, "DFI Excitedly Introduces Dual Specification Motherboard Adopting VIA KT266/DDR $\phi$ wAD72" it is taught that simply by using the V-link interconnect bus to connect the Northbridge to the Southbridge the bandwidth is increased by 100% (page 2) to an amazing 266MB per second.

It would have been obvious to one of ordinary skill in the art at the time of the applicant's invention to implement the bus connection between the high-speed and low-speed bridging circuits and the expansion bridge circuit as a V-link interconnect in order to increase the bandwidth by 100% over typical prior art interconnects.

8. Claim 10 is rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Admitted Prior Art (AAPA) in view of Peleg et al. (US006557065B1) further in view of Baxter, III (US006813689B2) as applied to claim 8 above, and further in view of what was commonly known at the time of applicant's invention as evidenced by Klein (US 5,935,226).

As previously discussed above AAPA in view of Peleg teaches a SOC with a bus connection to an expansion bridging circuit (Southbridge). The Southbridge circuit enables the SOC to increase the functionality and expandability of the embedded system. Baxter teaches that by connecting the Southbridge to both the high-speed and low-speed bridging circuits through a multiplexer that the delay required to move data from the Southbridge to various embedded system components is reduced. However, neither AAPA nor Peleg nor Baxter teaches the

Art Unit: 2112

specific protocol used to connect the high-speed/low-speed bridging circuits to the expanding bridge circuit (Southbridge).

The Examiner respectfully submits that it was well known at the time of applicant's invention to use a PCI bus to connect the Northbridge (the combination of the high-speed and low-speed bridging circuits) to the Southbridge as evidenced by Klein. Klein teaches as a matter of prior art (Fig. 1) that a Southbridge 30 is typically connected to the PCI bus 26 of the Northbridge 24.

It would have been obvious to one of ordinary skill in the art at the time of the applicant's invention to implement the bus connection between the high-speed and low-speed bridging circuits and the expansion bridge circuit as a PCI bus because it was a widely accepted Northbridge to Southbridge interconnect as evidenced by Klein.

### *Conclusion*

9. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

- MachZ: A high performance PC-on-a-chip including both a Northbridge and Southbridge along with various other system components.
- System-On-A-Chip Delivers Low-Power x86 PC Solution: The SiS55x integrated circuit includes both a Northbridge and Super-Southbridge along with other system components.
- Emerson, Bailis, Lary, and Brown disclose various system architectures implanting bridges between the CPU and peripheral devices.

Art Unit: 2112

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ryan M. Stiglic whose telephone number is 571.272.3641. The examiner can normally be reached on Monday - Friday (6:00-3:30).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Rehana Perveen can be reached on 571.272.3676. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

RMS



PAUL R. MYERS  
PRIMARY EXAMINER